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Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L7	1	("5346750").PN.	US-PGPUB; USPAT	OR	ON	2006/09/26 12:47
L8	147767	polyethyleneterephthalate poly\$1ethyleneterephthalate polyethylene\$1terephthalate poly\$1ethylene\$1terephthalate (poly adj ethyleneterephthalate) (polyethylene adj terephthalate) (poly adj ethylene\$1terephthalate) (poly\$1ethylene adj terephthalate) (poly adj ethylene adj terephthalate)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/26 12:59
L9	96827	(aluminum with hydroxide) aldrox alhydrogel alkagel alternagel alu\$1cap (alu adj cap) alucol aludrox aludyal alumigel (alumina adj trihydrate) (alumina adj trihydrate) (aluminum adj trihydrate) (aluminum adj hydrate) (amorphous adj alumina) amphogel amphojel antidiar dialume boehmite collumol creamalin cremorin fluagel gelumina (hydrated adj alumina) hycolal hydrolum merlium merlum pepsamar superfos uracid vanogel	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/26 12:59
L10	5674	(mold adj release) with (film or layer)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/26 12:59
L11	56	L10 and L8 and L9	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/26 13:04
L12	3	(L10 same L8) and ((10 or 8) same L9)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/26 13:03

L13	0	L7 and (L10 or L8 or L9)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/26 13:04
S1	1	"20040214006".pn.	US-PGPUB; USPAT; USOCR	OR	ON	2006/07/20 14:08
S2	5806	428/480.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/26 07:28
S3	486627	(circuit or wiring) adj board	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/26 07:33
S4	147767	polyethyleneterephthalate poly\$1ethyleneterephthalate poly\$1ethylene\$1terephthalate poly\$1ethylene\$1terephthalate (poly adj ethyleneterephthalate) (polyethylene adj terephthalate) (poly adj ethylene\$1terephthalate) (poly\$1ethylene adj terephthalate) (poly adj ethylene adj terephthalate)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/26 07:37
S5	96827	(aluminum with hydroxide) aldrox alhydrogel alkagel alternagel alu\$1cap (alu adj cap) alucol aludrox aludyal alumigel (alumina adj trihydrate) (alumina adj trihydrate) (aluminum adj trihydrate) (aluminum adj hydrate) (amorphous adj alumina) amphogel amphojel antidiar dialume boehmite collumol creamalin cremorin fluagel gelumina (hydrated adj alumina) hycolal hydrolum merlium merlum pepsamar superfos uracid vanogel	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/26 07:38

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S6	7	S2 and S3 and S4 and S5	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/26 10:42
S7	22	("6365844" "6459046" "6518514" "6518515" "6546624" "6558780" "6596381" "6671951" "6686029" "6691409" "6713688" "6734375" "6745464" "6753483" "6799369" "6866892" "6996902" "7018705" "7045198" "7047629" "7066344" "7103971").pn.	US-PGPUB; USPAT; USOCR	OR	ON	2006/09/26 07:42
S8	4	S7 and S3 and S4 and S5	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/26 08:36
S9	1	"20030137815".pn.	US-PGPUB	OR	ON	2006/09/26 08:36
S10	0	S9 and S3 and S4 and S5	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/26 08:36
S11	147767	polyethyleneterephthalate poly\$1ethyleneterephthalate polyethylene\$1terephthalate poly\$1ethylene\$1terephthalate (poly adj ethyleneterephthalate) (polyethylene adj terephthalate) (poly adj ethylene\$1terephthalate) (poly\$1ethylene adj terephthalate) (poly\$1ethylene adj terephthalate) (poly adj ethylene adj terephthalate)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/26 10:39
S12	5609049	film or (mold adj release) or layer	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/26 11:09

S13	96827	(aluminum with hydroxide) aldrox alhydrogel alkagel alternagel alu\$1cap (alu adj cap) alucol aludrox aludyal alumigel (alumina adj trihydrate) (alumina adj trihydrate) (aluminum adj trihydrate) (aluminum adj hydrate) (amorphous adj alumina) amphogel amphojel antidiar dialume boehmite collumol creamalin cremorin fluagel gelumina (hydrated adj alumina)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/26 10:45
S14	361492	hycolal hydrolum merlium merlum pepsamar superfos uracid vanogel (insulat\$4 adj layer) or prepreg or ((woven or nonwoven) with (aramid\$1 or impregnat\$4))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/26 10:44
S15	5806	428/480.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/26 10:42
S16	235	S15 and S11 and S13	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/26 10:43
S17	12	S15 and S11 and S12 and S13 and S14	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/26 10:49
S18	486627	(circuit or wiring) adj board	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/26 10:49

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S19	7	S15 and S18 and S11 and S13	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/26 10:49
S20	10	S17 not S19	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/26 10:56
S21	0	S11 and S12 and S13 and S14 and S18	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/26 10:58
S22	1	S11 and S12 and S13 and S14	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/26 10:57
S23	0	S11 and S12 and S13 and S14 and S18	FPRS	OR	ON	2006/09/26 10:58
S24	0	S11 and S12 and S13 and S14	FPRS	OR	ON	2006/09/26 10:58
S25	1	S11 and S12 and S13 and S14 and S18	USOCR	OR	ON	2006/09/26 10:59
S26	11	S11 and S12 and S13 and S14	USOCR	OR	ON	2006/09/26 10:59
S27	159	S11 and S12 and S13 and S14 and S18	US-PGPUB; USPAT	OR	ON	2006/09/26 10:59
S28	9	(S11 same S12 same S13) and S14 and S18	US-PGPUB; USPAT	OR	ON	2006/09/26 11:02
S29	13	(S11 with S12) and ((S11 or S12) with S13) and ((S11 or S12) with S14) and S18	US-PGPUB; USPAT	OR	ON	2006/09/26 11:09
S30	5674	(mold adj release) with (film or layer)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/26 12:58
S31	1	(S11 with S30) and ((S11 or S30) with S13) and ((S11 or S30) with S14) and S18	US-PGPUB; USPAT	OR	ON	2006/09/26 11:11
S32	1	(S11 with S30) and ((S11 or S30) with S13) and ((S11 or S30) with S14)	US-PGPUB; USPAT	OR	ON	2006/09/26 11:11

S33	123058	release with (film or layer)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/26 11:11
S34	1	(S11 with S33) and ((S11 or S33) with S13) and ((S11 or S33) with S14) and S18	US-PGPUB; USPAT	OR	ON	2006/09/26 11:11
S35	1	(S11 with S33) and ((S11 or S33) with S13) and ((S11 or S33) with S14)	US-PGPUB; USPAT	OR	ON	2006/09/26 11:11
S36	13	(S11 with S12) and ((S11 or S12) with S13) and ((S11 or S12) with S14) and S18	US-PGPUB; USPAT	OR	ON	2006/09/26 11:13
S37	1	(S11 with S12) and (S11 with S13) and ((S11 or S12) with S14) and S18	US-PGPUB; USPAT	OR	ON	2006/09/26 11:13